



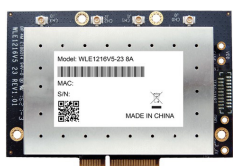
Wireless Module

Catalogue



Revision: 231018

802.11ac Wave 2



HARDWARE SPECIFICATIONS

TYPE OF CARD	Wide Size 4 x 4 MU-MIMO 802.11ac Wave 2	Standard size 4 x 4 MU-MIMO 802.11ac Wave 2	Standard size 3 x 3 MU-MIMO 802.11ac Wave 2	Standard size 2 x 2 MU-MIMO 802.11ac Wave 2	Standard size 2 x 2 MU-MIMO 802.11ac Wave 2
MIMO	4 x 4	4 x 4	3 x 3	2 x 2	2 x 2
MODEL	WLEI216V5-23	WLEI216V5-20	WLEI000V5-20	WLE650V5-25A	WLE650V5-18A
CHIPSET	QCA9984	QCA9984	QCA9982	QCA9888	QCA9888
STANDARD	802.11a/n/ac	802.11a/n/ac	802.11a/n/ac	802.11a/n/ac	802.11a/n/ac
THEORETICAL RATE	1733Mbps	1733Mbps	1300Mbps	867Mbps	867Mbps
FORM FACTOR	Wide size	Standard size	Standard size	Standard size	Standard size
SPECTRUM	5.180-5.825GHz	5.180-5.825GHz	5.180-5.825GHz	5.180-5.825GHz	5.180-5.825GHz
REFERENCE DESIGN	CUS239	x	x	x	x
HOST INTERFACE	MiniPCIe 2.0	MiniPCIe 2.0	MiniPCIe 2.0	MiniPCIe 2.0	MiniPCIe 1.2
OPERATING VOLTAGE	5V DC	3.3V DC	3.3V DC	3.3V and 5V DC	3.3V DC
POWER (PER CHAIN)	23dBm @ 5GHz	20dBm @ 5GHz	20dBm @ 5GHz	25dBm @ 5GHz	18dBm @ 5GHz
POWER CONSUMPTION	13W (Max)	8.5W (Max)	8.5W (Max)	9.49W (Max)	5.6W (Max)
CHANNEL SUPPORT	20 / 40 / 80 / 80+80MHz	20 / 40 / 80 / 80+80MHz	20 / 40 / 80MHz	20 / 40 / 80 / 80+80MHz	20 / 40 / 80 / 80+80MHz
ANTENNA CONNECTOR	4x U.FL	4x U.FL	3x U.FL	2x MMCX	2x U.FL
MODULATION TECHNIQUES	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM	BPSK, QPSK, DBPSK, DQPSK, 16-QAM, 64-QAM, 256-QAM
OPERATING ENVIRONMENT	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C
CERTIFICATION	N.A	N.A	N.A	N.A	N.A
DIMENSIONS (W x H x D) in mm	73.7 x 51.0 x 5.5	29.9 x 50.8 x 12.9	29.9 x 50.8 x 12.7	29.9 x 50.8 x 12.2	29.9 x 50.8 x 10.4

802.11ac Wave 1

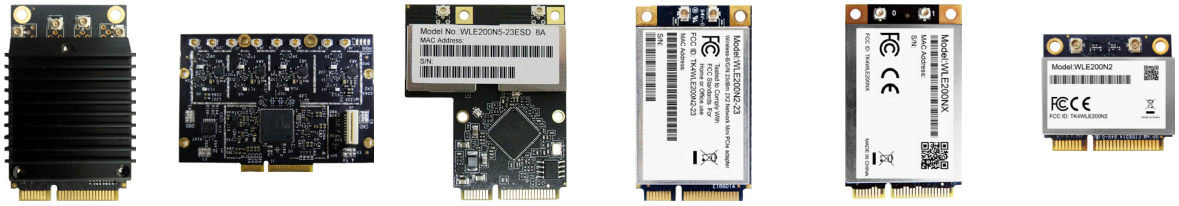


HARDWARE SPECIFICATIONS

TYPE OF CARD	Wide card High Power 2 x 2 MIMO 802.11ac	Wide card High Power 2 x 2 MIMO 802.11ac	Standard size 3 x 3 MIMO 802.11ac	Standard size Industrial Grade 3 x 3 MIMO 802.11ac	Standard size 2 x 2 MIMO 802.11ac	Standard size Industrial Grade 2 x 2 MIMO 802.11ac
MIMO	3 x 3	2 x 2	3 x 3	3 x 3	2 x 2	2 x 2
MODEL	WLE900V5-27ESD	WLE600V5-27ESD	WLE900VX	WLE900VX-I	WLE600VX	WLE600VX-I
CHIPSET	QCA9880	QCA9882	QCA9880	QCA9890	QCA9882	QCA9892
STANDARD	802.11a/n/ac	802.11a/n/ac	802.11a/b/g/n/ac	802.11a/b/g/n/ac	802.11a/b/g/n/ac	802.11a/b/g/n/ac
THEORETICAL RATE	1300Mbps	867Mbps	1300Mbps	1300Mbps	867Mbps	867Mbps
FORM FACTOR	Wide size	Wide size	Standard size	Standard size	Standard size	Standard size
SPECTRUM	5.180-5.825GHz	5.180-5.825GHz	2.412-2.472GHz 5.180-5.825GHz	2.412-2.472GHz 4.920-5.825GHz	2.412-2.472GHz 5.180-5.825GHz	2.412-2.472GHz 4.920-5.825GHz
REFERENCE DESIGN	CUS223 (High Power)	x	XB140	XB140	XB140	XB140
HOST INTERFACE	MiniPCIe 1.2	MiniPCIe 1.2	MiniPCIe 1.1	MiniPCIe 1.1	MiniPCIe 1.1	MiniPCIe 1.1
OPERATING VOLTAGE	3.3V and 5V DC	3.3V and 5V DC	3.3V DC	3.3V DC	3.3V DC	3.3V DC
POWER (PER CHAIN)	27dBm @ 5GHz	27dBm @ 5GHz	21dBm @ 2.4GHz 20dBm @ 5GHz	21dBm @ 2.4GHz 20dBm @ 5GHz	21dBm @ 2.4GHz 20dBm @ 5GHz	21dBm @ 2.4GHz 20dBm @ 5GHz
POWER CONSUMPTION	10W (Max)	7.5W (Max)	5W (Max)	5W (Max)	3.5W (Max)	3.5W (Max)
CHANNEL SUPPORT	20 / 40 / 80MHz	20 / 40 / 80MHz	20 / 40 / 80MHz	20 / 40 / 80MHz	20 / 40 / 80MHz	20 / 40 / 80MHz
ANTENNA CONNECTOR	3x MMCX	2x MMCX	3x U.FL	3x U.FL	2x U.FL	2x U.FL
MODULATION TECHNIQUES	BPSK, QPSK, DBPSK, DQPSK, 16-QAM, 64-QAM, 256-QAM	BPSK, QPSK, DBPSK, DQPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, DBPSK, DQPSK, CCK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, DBPSK, DQPSK, CCK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, DBPSK, DQPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, DBPSK, DQPSK, CCK, 16-QAM, 64-QAM, 256-QAM
OPERATING ENVIRONMENT	-40°C to 70°C with normal heatsink, -40°C to 80°C with large heatsink	-40°C to 70°C with normal heatsink, -40°C to 85°C with large heatsink	-20°C to 70°C	-40°C to 70°C*	-20°C to 70°C	-40°C to 70°C*
CERTIFICATION	N.A	FCC, CE, IC	FCC, CE	FCC, CE	FCC, CE	FCC, CE
DIMENSIONS (W x H x D) in mm	50 x 51 x 12.5 with normal heatsink, 95 x 51 x 13 with large heatsink	50 x 51 x 12.5 with normal heatsink, 95 x 51 x 13 with large heatsink	30 x 50.9 x 3.2	30 x 50.9 x 3.2	30 x 50.9 x 3.2	30 x 50.9 x 3.2

*The wireless module can operate up to 90°C. For long term reliability, it is recommended that a 20°C safety margin be maintained.

802.11n



HARDWARE SPECIFICATIONS

TYPE OF CARD	Standard size 4 x 4 MU-MIMO 802.11n	Wide size 4 x 4 MU-MIMO 802.11n	Wide size High Power 2 x 2 MIMO 802.11n	Standard size High Power 2 x 2 MIMO 802.11n	Standard size 2 x 2 MIMO 802.11n	Half size 2 x 2 MIMO 802.11n
MIMO	4 x 4	4 x 4	2 x 2	2 x 2	2 x 2	2 x 2
MODEL	WLEI216V2-20	WLEI200V2-22	WLE200N5-23ESD	WLE200N2-23	WLE200NX	WLE200N2
CHIPSET	QCA9984	QCA9980	AR9280	AR9283	AR9280	AR9287
STANDARD	802.11b/g/n	802.11b/g/n	802.11a/n	802.11b/g/n	802.11a/b/g/n	802.11b/g/n
THEORETICAL RATE	800Mbps	600Mbps	300Mbps	300Mbps	300Mbps	300Mbps
FORM FACTOR	Standard size	Wide size	Wide size	Standard size	Standard size	Half size
SPECTRUM	2.412-2.472GHz	2.412-2.472GHz	5.150-5.875GHz	2.412-2.484GHz	2.412-2.484GHz 5.150-5.875GHz	2.412-2.484GHz
REFERENCE DESIGN	x	CUS260	x	x	XB92	HB97
HOST INTERFACE	MiniPCIe 2.0	MiniPCIe 2.0	MiniPCIe 1.1	MiniPCIe 1.1	MiniPCIe 1.1	MiniPCIe 1.1
OPERATING VOLTAGE	3.3V DC	5V DC	3.3V DC	3.3V DC	3.3V DC	3.3V DC
POWER (PER CHAIN)	20dBm @ 2.4GHz	22dBm @ 2.4GHz	23dBm @ 5GHz	23dBm @ 2.4GHz	18dBm @ 2.4GHz 17dBm @ 5GHz	16dBm @ 2.4GHz
POWER CONSUMPTION	6.68W (Max)	15W (Max)	2.8W	2.5W	3.7W (Max)	1.9W
CHANNEL SUPPORT	20 / 40MHz	20 / 40MHz	20 / 40MHz	20 / 40MHz	20 / 40MHz	20 / 40MHz
ANTENNA CONNECTOR	4x U.FL	8x U.FL	2x MMCX or 2x U.FL	2x U.FL	2x U.FL	2x U.FL
MODULATION TECHNIQUES	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM DSSS: DBPSK, DQPSK, CCK	OFDM: BPSK, QPSK, 16-QAM, 64-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM DSSS: DBPSK, DQPSK, CCK	OFDM: BPSK, QPSK, 16-QAM, 64-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM DSSS: DBPSK, DQPSK, CCK
OPERATING ENVIRONMENT	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C	-20°C to 70°C
CERTIFICATION	FCC, CE	N.A	N.A	N.A	FCC, CE	FCC, CE, IC
DIMENSIONS (W x H x D) in mm	29.9 x 50.8 x 12.9	70.3 x 51 x 5.5	42.8 x 51.2 x 3.3	30.0 x 50.9 x 3.2	30 x 50.9 x 3.2	30 x 26.8 x 3.2

New Form Factors



HARDWARE SPECIFICATIONS

TYPE OF CARD	M.2 2230 2 x 2 MU-MIMO 802.11ac	System-on-chip (SoC) 1 x 1 WLAN and Bluetooth
MIMO	2 x 2	1 x 1
MODEL	WLT674	WSD377
CHIPSET	QCA6174A-5	QCA9377-3
STANDARD	802.11a/b/g/n/ac	802.11a/b/g/n/ac
THEORETICAL RATE	867Mbps	433Mbps
FORM FACTOR	M.2 2230, Key A+E	Single-die
SPECTRUM	2.412-2.472GHz 5.180-5.825GHz	2.412-2.472GHz 5.180-5.825GHz
REFERENCE DESIGN	x	x
HOST INTERFACE	M.2	SDIO
OPERATING VOLTAGE	3.3V DC	3.3V DC
POWER (PER CHAIN)	18dBm @ 2.4GHz 10.5dBm @ 5GHz	16dBm @ 2.4GHz 11dBm @ 5GHz
POWER CONSUMPTION	TX: 610mA RX: 280mA	3.83W (Max)
CHANNEL SUPPORT	20 / 40MHz @ 2.4GHz 20 / 40 / 80MHz @ 5GHz	20 / 40MHz @ 2.4GHz 20 / 40 / 80MHz @ 5GHz
ANTENNA CONNECTOR	2x U.FL connectors	SDIO
MODULATION TECHNIQUES	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM	OFDM: BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM
OPERATING ENVIRONMENT	-20°C to 70°C	-20°C to 70°C
CERTIFICATION	FCC, CE, IC	CE
DIMENSIONS (W x H x D) in mm	22 x 30 x 3	12 x 12 x 2.5